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2021 TECHCET's CMR™

CERAMIC

FABRICATED PARTS, MATERIAL SEGMENT
FOR SEMI-CONDUCTOR APPLICATIONS

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RESEARCH METHODOLOGY

TEHCET employs subject matter experts having first-hand experience within the industries which they analyze. Most of TEHCET's analysts have over 25 years of direct and relevant experience in their field. Our analysts survey the commercial and technical staff of IC manufacturers and their suppliers and conduct extensive research of literature and commerce statistics to ascertain the current and future market environment and global supply risks. Combining this data with TEHCET's proprietary, quantitative wafer forecast results in a viable long-term market forecast for a variety of process materials.

This report represents the interpretation and analysis of information generally available to the public or released by responsible agencies or individuals. Data was obtained from sources considered reliable. However, accuracy or completeness is not guaranteed.

ANALYST BIOGRAPHY



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Table of Contents

1	Executive Summary	11
1.1	Highlight Material Segment Business Overview	11
1.2	Alumina	13
1.3	Aluminum nitride & SiC	13
1.4	CVD SiC	14
1.5	Al ₂ O ₃ / HPA	14
1.6	Other Materials	14
1.7	M & A	15
2	Scope, Purpose and Methodology	16
2.1	Scope	16
2.2	Purpose	16
2.3	Methodology	16
2.4	Overview of Other TECHCET CMR™ Reports	17
3	Market Outlook	18
3.1	Semiconductor Industry Market Status & Outlook	18
3.2	Global Economy	18
3.2.1	Semiconductor Industries Ties to the Global Economy	20
3.2.2	Semiconductor Sales Growth	20
3.2.3	Taiwan Monthly Sales Trends	21
3.2.4	Semiconductor Industry Outlook	22
3.2.5	Semiconductor Units and Wafer Shipment Growth Forecast	23
3.3	Electronic Goods Market	24
3.3.1	Smartphones	24
3.3.2	PC Unit Shipments	25
3.4	Automotive Sales	27
3.4.1	Automotive Sales and Impact on Semiconductor Sales	27
3.4.2	Electric Vehicle (EV) Market Trends	28
3.4.3	Increase in Semiconductor Content for Autos	29
3.4.4	Semiconductor Content by Automotive Electronic System	30
3.4.5	Servers / IT	30
3.5	Semiconductor Fabrication Growth & Expansion	32
3.5.1	Equipment Spending Trends	32
3.5.2	Overall China Market Trends	35
3.5.3	Policy & Trade Trends and Impact	36
3.5.4	Policy and Trade Issues	36
3.5.5	U.S. CHIPS Act	37
3.5.6	Other Semiconductor Funding Activity	38
3.6	Semiconductor Materials Outlook	38
3.6.1	Wafer Start Growth	38
3.6.2	Materials Forecast	40

4	Material Market Drivers & Dynamics	42
4.1	Ceramic Material Applications and Suppliers	42
4.1.1	Thermal Processes	44
4.1.2	Dry Etching Process	45
4.1.3	Deposition: Plasma CVD and PVD	45
4.1.4	Epitaxial Process	45
4.2	Material Shortages and Supply Chain Constraints	46
4.3	Materials Trends (no significant changes since 2020)	47
4.4	Technical Drivers / Material Changes and Transitions (no significant changes since 2020)	47
4.4.1	Material Trends for the Leading-Edge	48
4.4.2	Trends/Impact/Status of Legacy Materials (200 mm & 150 mm)	48
4.5	Comment on Regional Trends/Drivers – China & Taiwan	49
4.6	EHS, Logistic, AND Exogenous (Weather) Market Issues	50
5	Supplier Market Landscape	52
5.1	Ceramics Overall Market Size and Forecast	52
5.1.1	Ceramic Components Fabricators:	53
5.2	Ceramic Suppliers Total Market Share Roll-up	57
5.2.1	COVID19 Impact on Ceramic Fabrication	58
5.3	Ceramic Component Market Summary	59
5.3.1	2020 to 2021 Market Dynamics – OEMS and Chip Fabs	60
5.4	M&A Activity	62
5.5	Expansions or New Plants of Existing Suppliers	64
5.6	Suppliers or parts/product line that are at risk of discontinuation	64
5.7	Pricing Trends	64
5.8	Aluminum Nitride (AlN) Market Segment	65
5.8.1	AlN Competitive Market Shares & Activity (no significant changes since 2020)	67
5.9	Alumina (Al₂O₃) and Other Oxides (BN, YtO, ZrO) Components	68
5.9.1	Tech Trends & Opportunities for Al ₂ O ₃	70
5.10	Silicon Carbide / CVD SiC Market Segment	72
5.10.1	CVD SiC	77
5.10.2	Alternatives to SiC Component Technology	79
5.11	Ceramics Market Regional Activity	79
5.12	Ceramic Fabrication by Process Segment	80
6	Sub tier material supply chain	82
6.1	Sub-Tier, Ceramic Blank Manufacturers (no significant changes since 2020)	82
6.2	Alumina (Al₂O₃) Production Process	83
6.2.1	Vertically Integrated Alumina Producers	86
6.3	Silicon Carbide – SiC Sub-tier Players & Price Points	86
6.4	Yttria Powder Production Players & Price Points	87
6.5	M&A of Raw Materials Companies	87
6.6	New Plants or Expansions	88
6.7	Plant Closures & Products at risk of discontinuation	88
7	Supplier profiles (Fabricators)	89

7.1	Applied Ceramics	89
7.1.1	Business Segments	89
7.1.2	Regions Served	90
7.1.3	Sales Reps and Distributors	90
7.2	Ariake Material Company	91
7.2.1	Business Segments	91
7.2.2	Financial Overview	92
7.2.3	Manufacturing Locations, Capabilities, and Accreditations	92
7.2.4	Sales Reps and Distributors by Region	92
7.3	Asahi Glass Company, Ltd. (AGC)	93
7.3.1	Business Segments	93
7.3.2	Financial Overview	93
7.3.3	News	94
7.3.4	Key Customers	94
7.3.5	Manufacturing Locations, Capabilities, and Accreditations	94
7.3.6	Sales Reps and Distributors by Region	95
7.4	Asuzac	96
7.4.1	Business Segments	96
7.4.2	Financial Overview	96
7.4.3	Manufacturing Locations, Capabilities, and Accreditations	96
7.4.4	Sales Reps and Distributors by Region	97
7.5	Carborundum Universal Ltd (CUMI)	97
7.5.1	Business Segments	97
7.5.2	Fiscal Year Financial Overview	98
7.5.3	Manufacturing Locations, Capabilities, and Certifications	98
7.5.4	JVs and Partnerships	98
7.6	Ceradyne (3M)	99
7.6.1	Business Segments	99
7.6.2	Fiscal Year Financial Overview	99
7.6.3	JVs and Partnerships	99
7.7	Ceramic Tech	99
7.7.1	Business Segments	100
7.7.2	Recent Company Specific News and New Product Offerings	100
7.7.3	Manufacturing Locations, Capabilities, and Certifications	100
7.7.4	Sales Reps and Distributors	101
7.8	CeramTec	101
7.8.1	Business Segments	101
7.8.2	Fiscal Year Financial Overview	102
7.8.3	Manufacturing Locations, Capabilities, and Certifications	102
7.8.4	Recent Company Specific News and New Product Offerings	103
7.8.5	JVs and Partnerships	104
7.8.6	Sales Reps and Distributors	104
7.9	CoorsTek, Inc.	105
7.9.1	Business Segments	106
7.9.2	Manufacturing Locations, Capabilities, and Certifications	106

7.9.3	Recent Company Specific News and New Product Offerings	108
7.9.4	JVs and Partnerships	109
7.9.5	Sales Reps and Distributors	109
7.10	Dow DuPont (DuPont Electronics & Imaging)	111
7.10.1	Business Segments	111
7.10.2	Fiscal Year Financial Overview	112
7.10.3	Recent Company Specific News and New Product Offerings	112
7.10.4	Sales Reps and Distributors Locations	113
...and many more		
8	Appendices	192

TABLE OF FIGURES

Figure 1: Total Ceramics Market Forecast and Growth Estimates (2018-2025)	13
Figure 2: Global Economy and the Electronics Supply Chain (2020)	22
Figure 3: Worldwide Semiconductor Sales	23
Figure 4: Monthly Sales Trends of Taiwan Outsource Manufacturers	24
Figure 5: Semiconductor Revenues 2021	25
Figure 6: Semiconductor Wafer Area Shipments	25
Figure 7: 2020 Semiconductor Chip Applications	26
Figure 8: Mobile Phone Shipments WW Estimates	27
Figure 9: PC Notebook Shipments	27
Figure 10: U.S. Automotive Sales	28
Figure 11: Monthly Automotive Sales Trends	29
Figure 12: Global EV Trends	30
Figure 13: Semiconductor Spend per Vehicle Type	30
Figure 14: Semiconductor Content by Automotive Application	31
Figure 15: 3-month Average Semiconductor Equipment Billings	32
Figure 16: Capital Spending Trends by Technology Node	33
Figure 17: Overview of Logic Roadmap Trends	33
Figure 18: China IC Market and Production Trends	35
Figure 19: Leading-Edge Device Node Wafer Starts	38
Figure 20: Other Logic (12nm & above) and Device Wafer Starts	39
Figure 21: Global Semiconductor Materials Outlook	41
Figure 22: Ceramic Products for Semiconductor Applications	43
Figure 23: Fabricated Ceramics Components for Thermal Process	44
Figure 24: Fabricated Ceramics Components for Dry Etching Process	45
Figure 25: Total Ceramics Market Forecast and Growth Estimates (2018-2025)	53
Figure 26: 2020 Market Shares for All Ceramics (incl. SiC/CVD SiC)	56
Figure 27: WW Ceramics Components Forecast	59
Figure 28: Aluminum Nitride (AlN) Components Forecast and Growth Estimate	64
Figure 29: AlN Parts Fabricator Market Share Estimates (as a % of total revenues)	67
Figure 30: Alumina (+ other oxides) Component Revenue Forecast Estimate	68

Figure 31: Alumina + BN, YtO, ZrO Parts Fabricator Market Share Estimate (as a % of total revenues)	69
Figure 32: Al ₂ O ₃ Semiconductor Components Revenues (\$M's)	70
Figure 33: 99.8% and HPA (99.99) Alumina Components Forecast (metric tons)	71
Figure 34: Silicon Parts, SiC Segments as a Percent of Total Revenues	72
Figure 35: CVD Components Market Revenues (\$M's USD)	72
Figure 36: SiC (+ CVD SiC) Components Market Shares (as a % of total revenues)	74
Figure 37: CVD SiC Components Market Forecast	75
Figure 38: CVD SiC Components by Share of Application (as % of total revenues)	76
Figure 39: CVD SiC Components Relative Pricing	77
Figure 40: 2020 Regional Shares of Equipment Components (% of end-use location)	78
Figure 41: Equipment and Silicon Parts Demand by for Logic and DRAM Technology Nodes	79
Figure 42: Global Bauxite Mining Locations (as a % of total metric tons)	82
Figure 43: Alumina Production by Region (as a % of total metric tons)	83
Figure 44: Specialty Alumina Powder by Supplier (Raw Material as a % of total metric tons)	83

TABLES

Table 1: Ceramic Segment Revenues and CAGRs	15
Table 2: 2021 TECHCET Critical Material Reports	19
Table 3: Global GDP and Semiconductor Revenues*	20
Table 4: World Bank World Economic Outlook	21
Table 5: Data Center Systems and Communication Services Forecast 2021	32
Table 6: Recent Investment and Fab/Plant Expansion Activity	34
Table 7: US Chips Act Provisions	37
Table 8: Total Fabricated Ceramic Components Revenue History and Forecast*	52
Table 9: Ceramic Fabricators (including SiC) Offerings	54
Table 10: 2020 TECHCET WW Ceramics Components 5-year Forecast	59
Table 11: Total SiC Components Market Revenues Forecast and CVD SiC Split (\$M's USD)	74
Table 12: Ranking of Ceramic Blank Manufacturers	81
Table 13: Product Offerings and Purity of Leading Alumina Powder Producers	84
Table 14: High Purity Silicon Carbide Powder Producers Ranking	85
Table 15: Ceramic Powder Suppliers & Capabilities	191

2 SCOPE, PURPOSE AND METHODOLOGY

2.1 SCOPE

This report is focused on technical ceramic materials market and supply-chain which includes SiC/ CVD SiC, AlN, Al₂O₃, Y₂O₃, and BN used in the production of components and assemblies for use in semiconductor process equipment. We gathered information from primary research (field interviews), commonly available industry information, patent and IP (intellectual property) based knowledge, and combined this with available data base information to form the basis of this report.

SiC is frequently used for both carriers (boats, gas injectors, and fabware) and components for OEMs where high temperature or specific thermal packages are required, while traditional Al₂O₃ and AlN ceramics are normally used for lower temperature / etch applications.

The machines/tools manufacturers that use these components are referred to as OEMs (Original Equipment Manufacturers). This report targets ceramics used in the manufacture of semiconductors, only. The report contains data and analysis from TECHCET's data base and Sr. Analyst experience, as well as that developed from primary and secondary market research. For more information on TECHCET Critical materials Reports™ please go to <https://TEHCET.com>

2.2 PURPOSE

This Critical Materials Report™ (CMR) provides focused information for supply-chain managers, process integration and R&D directors, as well as business development managers, and financial analysts. The report covers information about key suppliers, issues/trends in the material supply chain, estimates on supplier market share, and forecast for the material segments.

This report aims to provide an overview to the above scope ceramic material and parts supply chain, serving the semiconductor industry. This information about this critical material is essential in the running of the semiconductor wafer fabs across the world. The goal is to annually track the state of the industry; the health of the supply and demand; to pinpoint any shortcomings or issues faced by the industry; and to provide a guidance for purchasing and industry quality improvement decisions. We hope to provide a dialog and feedback opportunities for related stakeholders to fine-tune and better manage the supply ups and downs.

2.3 METHODOLOGY

TEHCET employs subject matter experts having first-hand experience within the industries which they analyze. Most of TECHCET's analysts have over 25 years of direct and relevant experience in their field. Our analysts survey the commercial and technical staff of IC manufacturers and their suppliers and conduct extensive research of literature and commerce statistics to ascertain the current and future market environment and global supply risks. Combining this data with TECHCET's proprietary, quantitative wafer forecast results in a viable long-term market forecast for a variety of process materials.

We track micro-economic and macro-economic trends pertaining to the semiconductor industry and track overall industry trend and needs, equipment supply and demand situation, deduction towards the quartz material requirement, and supplier/fabricators situation one by one. From this vantage point, we check the suppliers/fabricators and the base material company information, and then the raw materials market information. Included in our work is an analysis of public information, website information, supplier interviews, supplier surveys, supplier peer-data cross-checking, and reference comparison. In addition, we conduct a material base usage calculation with respect to a demand and supply micro-economic analysis. We then conduct a forward and backward sweep of the forecast until data is in sync. In the meantime, for the data points that are missing, we use past historic, forward-looking data, and peer data so to extrapolate from three different levels of cross-checking. This provides us an estimation based on judgment from industry experience. In this year's report, we especially added special industry situation reporting and analysis for exogenous factors affecting the industry, which can be big percentage influence factors than normal trend parameter contributors.

2.4 OVERVIEW OF OTHER TECHCET CMR™ REPORTS

TEHCET produces electronic material supply chain reports each year as one of its functions for the Critical Materials Council. Reports to be published in 2019 can be found at www.techcet.com and are listed in the table below:

Table 2: 2021 TECHCET Critical Material Reports

TEHCET REPORTS
1. CMP Consumables (Slurry, Pads, Disks)
2. Equipment Components- Quartz
3. Gases + Xeon/Neon
4. Photoresist
5. Precursors –Dielectric Precursors
6. Precursors –Hi K / ALD CVD Metal Precursors
7. Silicon Wafers
8. Specialty Chems / Wet Chems
9. Equipment Components- Silicon, SiC, Ceramics
10. Metal Chemical
11. Targets
12. Equipment Components – Silicon 2020 version with 2021 forecast